

BST-505 Bga 0.2mm-0.65mm

PRODUCT DISPLAY



BST-505
High: 35mm
Width: 16mm

PRODUCT DETAILS



A bottle of 25,000



PRODUCT PHOTOGRAPH



| | | | |
|-----------------|---|-------|-------------|
| Brand: | BST | Name: | solder ball |
| Ingredients: | alloy:Sn63/Pb37 | Size: | 16*35mm |
| Specifications: | 0.2mm (55.4g/10bottle), 0.25mm (68.5G/10bottle), 0.3mm (65.8G/10bottle), 0.35mm (74G/10bottle), 0.4mm (86.3G/10bottle), 0.45mm (100.8 G/10bottle), 0.5mm (119.7G/bottle10), 0.55mm (142.7G/10bottle), 0.6mm (167.7G/10bottle) | | |
| Quantity: | 25,000 / bottle | | |
| Features: | Tin ball is mainly connected to semiconductor wafers and circuit boards and PCB boards, and small ball type tin electronic parts that transmit electronic signals. | | |

